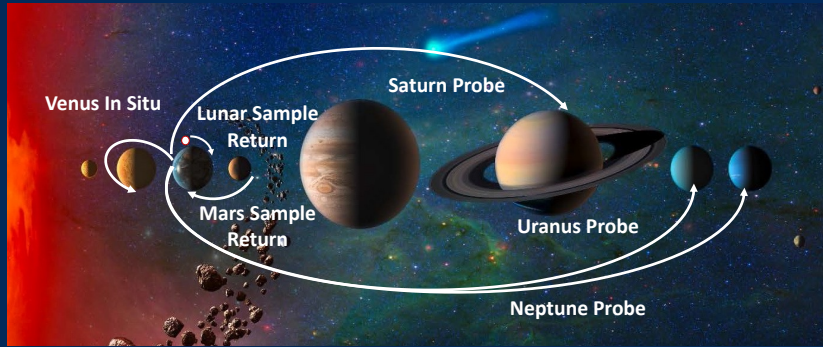
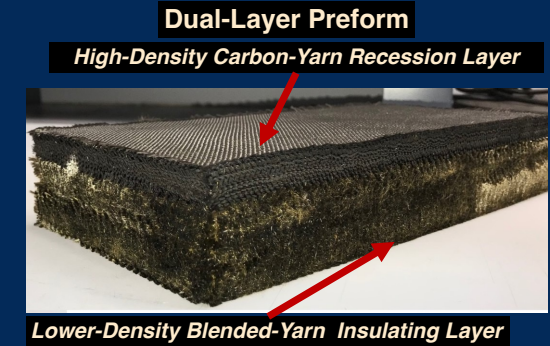
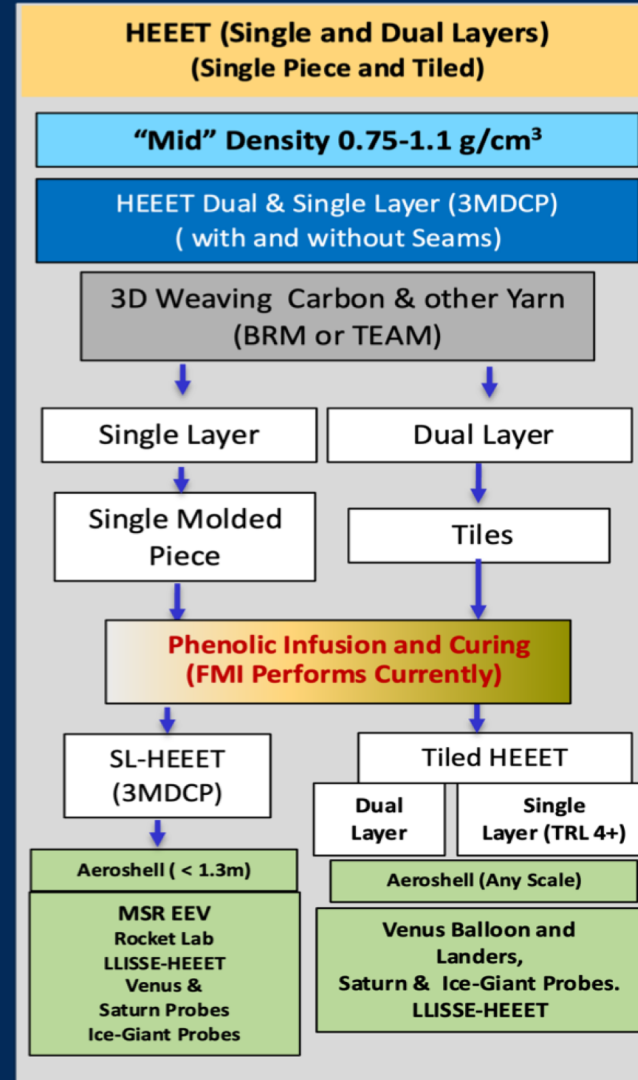
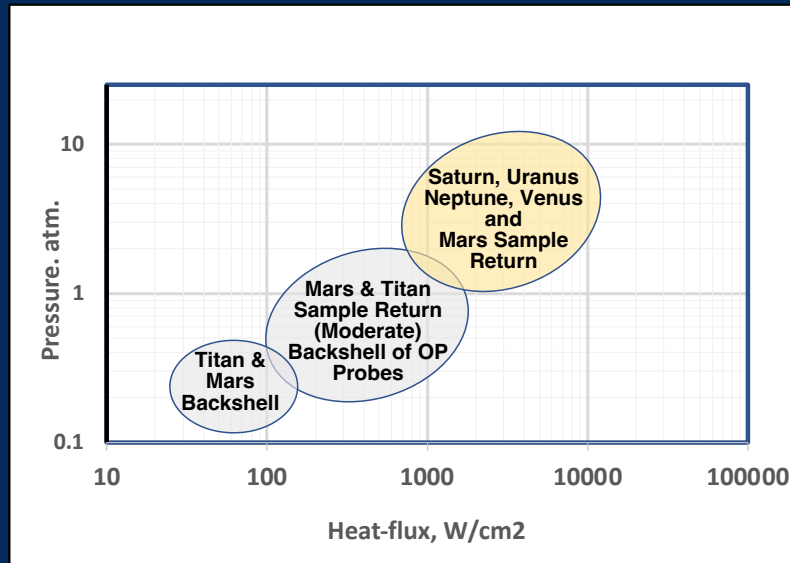


3-D Woven TPS Enabling Solar System In-Situ Science Missions



Destinations and Entry Environment



Dual-Layer HEET
 Seamless,
 Single-Layer
 3MDCP

Ethiraj Venkatapathy

Representing HEET and 3MDCP Development Team, NASA Ames Research Center, Moffett Field, CA 94035, USA